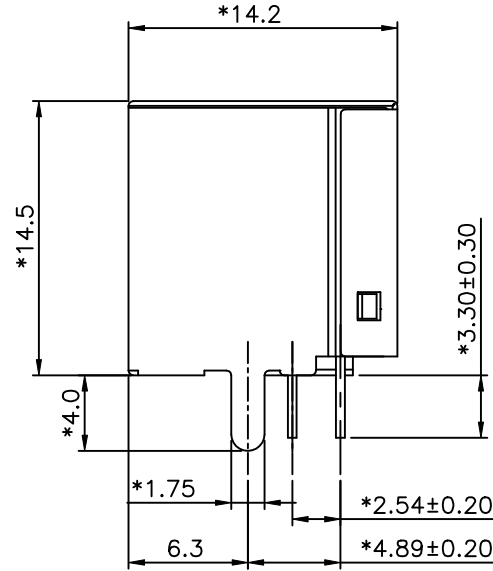
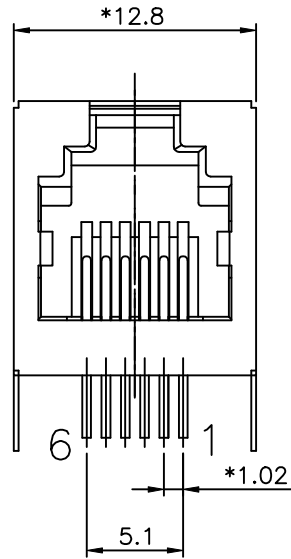


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		MODIFY P/N	HAOQIN 7/13/05	
△		MODIFY DESIGN	ANKUE 11/11/05	



NOTES:

ELECTRICAL:

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP.
- CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

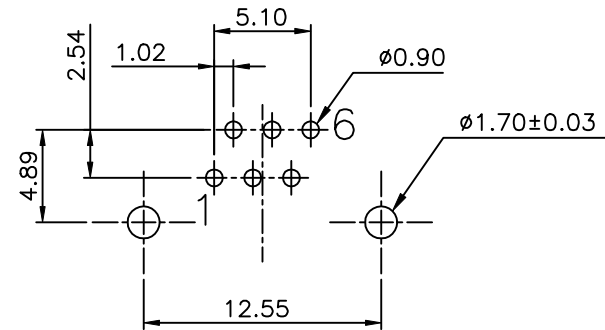
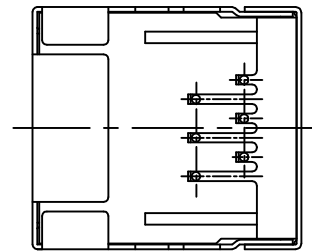
MECHANICAL:

- HOUSING MATERIAL : NYLON+30%.G.F(FR52) UL94V-0.
- STANDARD COLOUR : BLACK
- CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN.
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

- STORAGE : -40°C TO $+85^{\circ}\text{C}$.
- OPERATION: 0°C TO 70°C .
- WAVE SOLDERING TEMPERATURE: 255°C ~ 265°C (5~10 SECONDS)

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.



PC Board t=1.60mm
PC Board Layout Component Side Shown

ROHS PART NUMBER: E556X-6XLUEX-L △

- | | | |
|-----------------|-------------------|------------|
| NO. OF CONTACT: | 1- 3u" | 2- 6u" |
| | 3- 15u" | 4- 30u" |
| | 5- 50u" | 6- Pd 20u" |
| | SHIELD PLATING: | |
| | 1- TIN PLATING | |
| | 3- NICKEL PLATING | |

DETACHED LISTS	MM (INCH)	DFTO JAMY	DATE 5/31/05	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED	CHKD YICAN	DATE 2005/11/11		
	MM	MFO	DATE	TITLE HS'G, MINI L/P SIDE ENTRY PCB GANG JACK	
	.0 ± 0.2	APPVILLUSHENG	DATE 2005/11/11		
.00 ± 0.15	MATERIAL :		DRAWING NO. GE553A42-LA		
.000 ± 0.075	ANGLES ± 0.5		/PART NO. SEE NOTE		
THIRD ANGLE PROJECTION	FINISH :		DO NOT SCALE DRAWING		
	SCALE : 3.63:1		SHEET 1 OF 1		